

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNORS (Inventors):

Name: Min-Hsun Hsieh Nationality: R.O.C.
Address: No.48, Park Ave. II, Science-Based Industrial Park, Hsin-Chu City, Taiwan, R.O.C.

Name: Tzu-Feng Tseng Nationality: R.O.C.
Address: No.48, Park Ave. II, Science-Based Industrial Park, Hsin-Chu City, Taiwan, R.O.C.

Name: Wen-Huang Liu Nationality: R.O.C.
Address: No.48, Park Ave. II, Science-Based Industrial Park, Hsin-Chu City, Taiwan, R.O.C.

Name: Ting-Wei Yeh Nationality: R.O.C.
Address: No.48, Park Ave. II, Science-Based Industrial Park, Hsin-Chu City, Taiwan, R.O.C.

Name: Jen-Shui Wang Nationality: R.O.C.
Address: No.48, Park Ave. II, Science-Based Industrial Park, Hsin-Chu City, Taiwan, R.O.C.

Hereby sells, assigns and transfers to **EPISTAR CORPORATION**

(hereinafter 'Assignee'), of (Assignee address)

No.48, Park Ave. II, Science-Based Industrial Park, Hsin-Chu City, Taiwan, R.O.C.

, and the successors assigns and legal representatives of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"LIGHT EMITTING DIODE HAVING AN ADHESIVE LAYER AND A MANUFACTURING METHOD THEREOF"

Which is found in :

- (a) _____ U.S. patent application executed on even date
(b) _____ U.S. patent application executed on _____
(c) _____ U.S. application serial no. _____
(d) _____ patent no. _____ issued _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or ant continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this _____ (Date of signing).

(Type name of inventor)

Signature of INVENTOR

Min-Hsun Hsieh

Min-Hsun Hsieh

Tzu-Feng Tseng

Tzu-Feng Tseng

Wen-Huang Liu

Wen-Huang Liu

Ting-Wei Yeh

Ting-Wei Yeh

Jen-Shui Wang

Jen-Shui Wang

COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor , I hereby declare that :

I believe I am the sole (if only one name appears below) , or joint (if more than one name appears) , original and first inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled :

"LIGHT EMITTING DIODE HAVING AN ADHESIVE LAYER AND A MANUFACTURING METHOD THEREOF"

 + The specification for the above entitled invention is filed herewith.

 The specification for the above entitled invention was filed previously

with application serial number: Filing Date:

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of the invention disclosed in this application in accordance with Title 37, Code of Federal Regulations, Section 1.56 (a). I further acknowledge the duty in any continuation-in-part application to disclose to the Patent and Trademark Office all information known to be material to the patentability of the invention disclosed in this application, as defined in 1.56, which became available to me between the filing date of the prior application and the filing date of this application.

PRIORITY CLAIM

 There is no claim of priority

 + Claim of priority is based on the following:

Division Application of No. 10/604,352

Filing date : 2003/7/14

POWER OF ATTORNEY

As a named inventor, I hereby appoint the following attorneys to prosecute this application and to transact all related business in the Patent and Trademark Office:

Winston Hsu	Registration# 41,526	WinstonHsu@naipo.com.tw
Mord Michael Lewis	Registration# 50,478	MikeLewis@naipo.com.tw

P.O. Box 506,
Merrifield, Virginia 22116,
U.S.A
TEL: (02)8923-7350

DECLARATION

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued hereon.

Date: 7/2/2003

Min-Hsun Hsieh

Printed Name:
Post Office Address:
and Residence
Citizen of:

Min-Hsun Hsieh

No.48, Park Ave. II, Science-Based Industrial Park,
Hsin-Chu City, Taiwan, R.O.C.
R.O.C.

Date: 7/7/2003

Tzu-Feng Tseng

Printed Name:
Post Office Address:
and Residence
Citizen of:

Tzu-Feng Tseng

No.48, Park Ave. II, Science-Based Industrial Park,
Hsin-Chu City, Taiwan, R.O.C.
R.O.C.

Date: 7.3.2003

Wen-Huang Liu

Printed Name:
Post Office Address:
and Residence
Citizen of:

Wen-Huang Liu

No.48, Park Ave. II, Science-Based Industrial Park,
Hsin-Chu City, Taiwan, R.O.C.
R.O.C.

Date: 7.3.2003

Ting-Wei Yeh

Printed Name:
Post Office Address:
and Residence
Citizen of:

Ting-Wei Yeh

No.48, Park Ave. II, Science-Based Industrial Park,
Hsin-Chu City, Taiwan, R.O.C.
R.O.C.

Date: 7.3.2003

Jen-Shui Wang

Printed Name:
Post Office Address:
and Residence
Citizen of:

Jen-Shui Wang

No.48, Park Ave. II, Science-Based Industrial Park,
Hsin-Chu City, Taiwan, R.O.C.
R.O.C.